FLUX GEL EO-B-007

Cat.-no. 4697
Electronic flux gel, highly active, halogen-free activated
ISO-9454: 2231 / DIN EN 61190-1-1: ORL0
(WEEE/RoHS-konform)

This flux gel was developed for repair work on printed circuit boards.
The activator base contains the same active ingredients as the comparable electronic flux EO-B-007A, EO-B-007B and EO-B-007C. **FLUX GEL EO-B-007** is highly concentrated and is characterized due to high activity and good wetting and spreading. Due to these properties, the paste should be applied sparingly. The gel is applied from a dosing syringe via metal dosing needles. These allow a precise application or positioning of the flux.
The processing of **FLUX GEL EO-B-007** can be done by hot air or soldering iron.

Advantages of using **FLUX GEL EO-B-007**:
(ISO-9454: 2231 (2.2.3.C)

- Ideal when using flux EO-B-007 (A-C), uniform activator base
- Perfect soldering results
- Economical in consumption
- Also contaminated (old) pads and component pins are activated
- Paste is stable and shows no signs of polymerization (no sticking)
- Careful and targeted dosage
- Metal dosing needle is thermally resilient and can be used during use be used with the hot air or soldering iron
- Leaves no sticky residue

Applications:
- Repair work on printed circuit boards
- Dip tinning

In individual cases, which must be checked by the user, this flux gel can also support the wave soldering of critical components. The application is carried out as described above

Standard packaging units:

Syringes (including dosing tip and cap) with 5 ml or 10 ml.

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